## DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare:

That my residence, post office address and citizenship are as stated below next to my name.

That I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SILICON WAFER, ITS MANUFACTURING METHOD, AND ITS MANUFACTURING APPARATUS the specification of which (check one) is attached hereto. () was filed on November 14. (X) Application Serial No. PCT/JP03/14509 and was amended on November 22 (if applicable) That I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. That I acknowledge the duty to disclose information known to be material to patentability of this application in accordance with Title 37. Code of Federal Regulations, §1.56(a). That I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate on this invention having a filing date before that of the application on which priority is claimed: Priority Claimed Prior Foreign Application(s) х Yes No 14/11/2002 2002-331288 (Day/Month/Year Filed) (Number) (Country) 24/02/2003 2003-046411 Japan Yes No (Day/Month/Year Filed) (Country) (Number) That all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon. **POWER OF ATTORNEY** I hereby appoint the attorneys associated with Customer Number 24628, of the law firm of WELSH & KATZ, LTD. with full power of substitution and revocation, to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith. CORRESPONDENCE ADDRESS The address associated with Customer Number: LSH & KATZ, LTD. Phone: (312) 655-1500) Should be used for all correspondence in this application.

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5 the same of colo or second	Koji YOSHIHARA
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